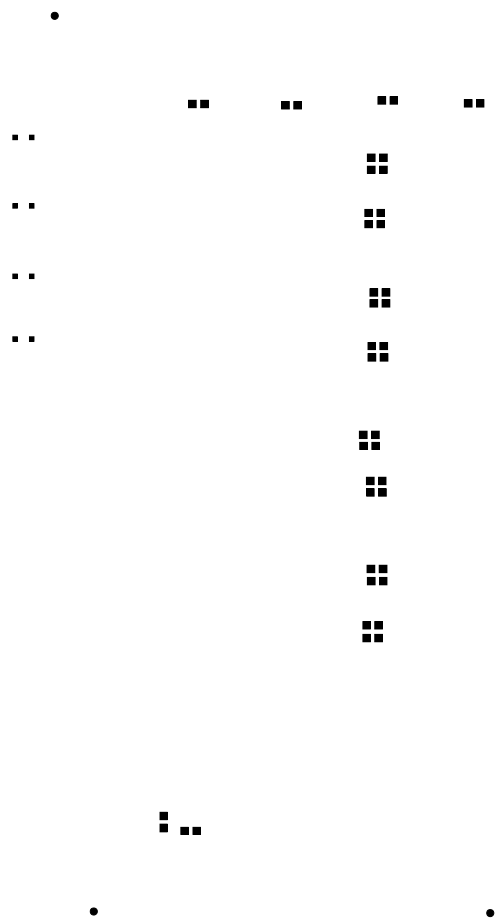
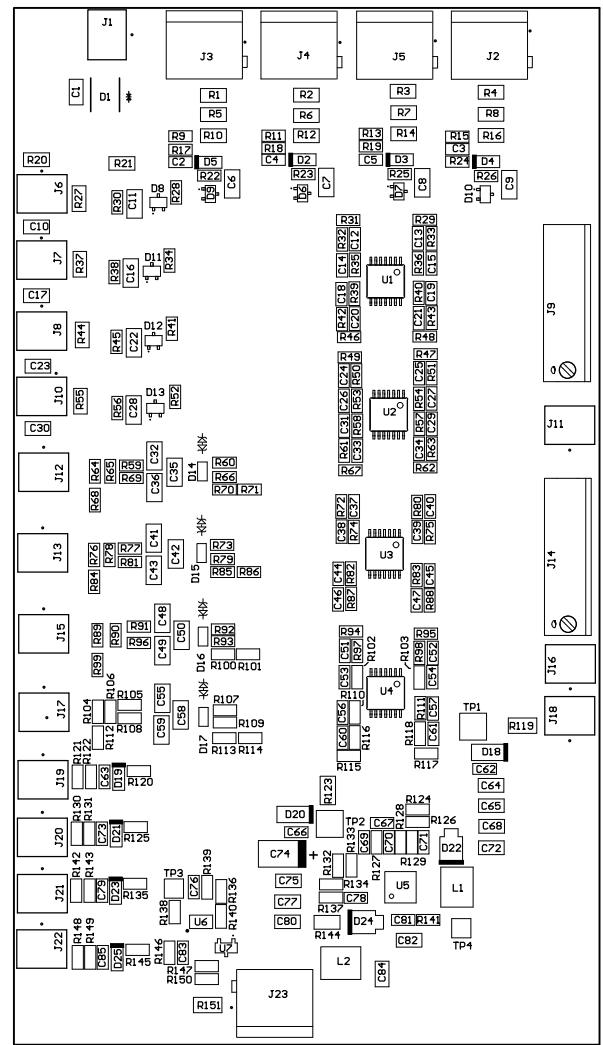


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00493	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Paste			
TIDA-00493_E2.GTP	GENERATED : 5/22/2015 12:12:37 PM	TEXAS INSTRUMENTS	



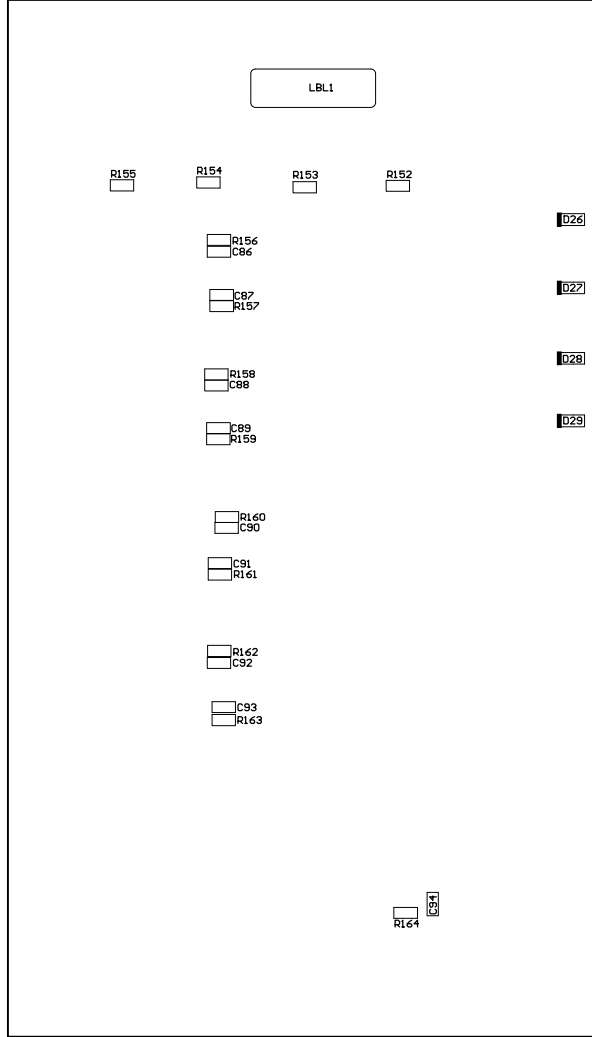
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00493	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
TIDA-00493_E2.GBP	GENERATED : 5/22/2015 12:12:37 PM	TEXAS INSTRUMENTS	

Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be 8 pt font. Text shall be 8 pt font.  
 Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.  
 Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.  
 Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



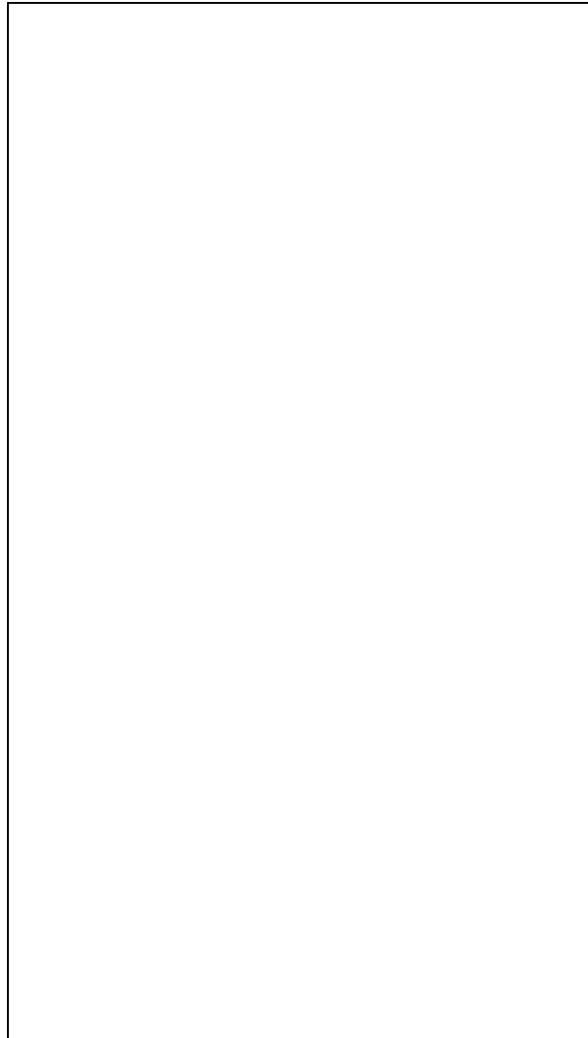
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-00493	REV:	E2	SUN REV:	Not In VersionControl
LAYER NAME =	M5 Assembly Top					
TIDA-00493_E2.GMS	GENERATED :	5/22/2015	12:16:40 PM	TEXAS INSTRUMENTS		



PCB VIEWED FROM BOTTOM SIDE	BOARD # : TDA-00493	REV: E3	SUN REV: NOT IN VERSION CONTROL
LAYER NAME = Mfg Assembly Bottom	IGNORE ->		
PLOT NAME = TDA-00493_E3.dwg	GENERATED : 2/22/2018	12:14:40 PM	

ASSEMBLY VARIANT: (No Variants)  
 COMPONENTS MARKED 'IMP.' SHOULD NOT BE POPULATED.



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00493	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
TIDA-00493_E2.GM1	GENERATED : 5/22/2015 12:19:23 PM	TEXAS INSTRUMENTS	

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